# Model 5110C

# Single Chuck Coater

#### **APPLICATIONS**

- · Positive resist coatings on wafers, masks and substrates
- · Negative resist coating on wafers, masks and substrates
- · PMMA and E-Beam resist coating
- Silicon, GaAs, InP and other semiconductor materials
- · Polyimide coatings on wafers, masks and substrates
- · Photosensitive polyimide coating
- · Multi-layer resists

### **FEATURES**

- · Single chuck for wafers, masks or substrates
- Solitec proprietary diaphragm type dispense pump
- 100Å, 3 sigma, full radius uniformity across a wafer
- Selectable process functions
- · Downflow exhaust system for backsplash control
- N<sub>a</sub> motor purge and interlock
- Vacuum interlock on wafer chuck
- Optional auto solvent dispense for HMDS
- 5 gallon drain bucket with exhaust
- Closed loop servo speed control for tight process control
- 1,000 to 40,000 rpm/sec acceleration
- · High uptime, easy maintenance design
- · Polypropelene waste container
- Digital tachometer with direct optical encoder
- · ± 10 rpm spin speed control
- Solvent dispense before coating (optional)
- · N, blow-off (optional)
- One wafer chuck and loading paddle included

# PRODUCT DESCRIPTION

The 5110C is a manual load/unload spinner with automatic resist dispensing, spin timing and a 2-speed spread control. The system dispenses a selected amount of resist at low spin speed. A high-speed spin stretches the resist to its final thickness. The quantity of resist dispensed, spindle speeds, dwell and spin times are all variable and can be selected in advance. This allows the user to achieve predictable results, time and time again. An exhaust fan is mounted under the process bowl to allow continuous exhaust flow around the process area. A side mounted belt drive motor with N<sub>2</sub> purge, keeps solvents away from all moving parts. The Solitec diaphragm pump allows for accurate dispense volumes every time, and the adjustable teflon valve guarantees accurate and repeatable suckback.



# SYSTEM SPECIFICATIONS

#### Wafer Handling

Manual with loading paddle to center wafer

#### Solvent Dispense

Pressurized tank required

#### Substrate Sizes (Max.)

9" round, 6" square, 9" diagonal rectangular

#### Tachometer

Digital readout from optical encoder

10 rpm resolution

#### Acceleration

Variable from 1,000 to 40,000 rpm/sec

#### **Process Control**

Digital timers with manual programming Relay logic

#### Time

Variable from 1 to 999 seconds in 1 second increments Resist Dispense

Automatic Teflon diaphragm pump with precise dispense adjustment; 0.5 to 38 ml±1%; viscosity 4 to 10,000 centistokes; separate drawback adjustment

# Speed Control

Closed loop servo with ±10 rpm speed ∞ntrol Adjustable from 200 to 10,000 rpm

Digital reference on spin and spread speeds

#### Standard Process Sequence

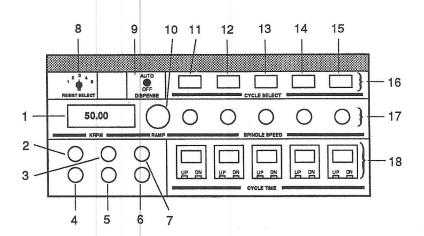
Resist coat (static or dynamic)

Spread

Spin

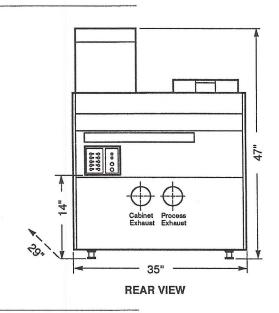
## SYSTEM CONTROL PANELS

- 1. Digital Tachometer
- 2. Power ON/OFF
- 3. Vacuum ON/OFF
- 4. Start
- 5. Emergency Stop
- 6. Motor Purge Interlock
- 7. Vacuum Interlock
- 8. Resist Select
- 9. Dispense AUTO/OFF
- 10. Spindle Acceleration
- 11. Solvent (optional)
- 12. Nitrogen (optional)
- 13. Resist Dispense
- 14. Spread
- 15. Spin
- 16. Cycle Select
- 17. Spindle Speed
- 18. Digital Timers



#### **FACILITIES AND INSTALLATION SPECIFICATIONS**

Facilities	Flexible Tubing O.D.	5110C
Nitrogen – SCFM at 60 PSI Vacuum– Inches HG @ .20CFM		
Power Volts		115V
Amps Process Exhaust – SCFM at .5" of water		
Cabinet Exhaust –  SCFM at .5" of water		
Shipping Weight		



### **PROCESS OPTIONS**

#### Option A - P/N 5110C-1 N<sub>2</sub> Spin

Resist dispense Spread speed spin Final high speed spin Option B - P/N 5110C-2 Solvent Dispense (Tank required) Spin dry (No N<sub>2</sub>) Resist dispense Spread speed spin Final high speed spin

#### Option C - P/N 5110C-3

Solvent dispense (tank required)

N. Spin

Resist dispense

Spread speed spin

Final high speed spin

#### **EQUIPMENT OPTIONS**

• Extra Resist Pumps - P/N 0967

Note: The 5110C can have up to total of 4 dispenses Example: You can have 4 resist dispenses w/no  $N_2$  blow or solvent dispenses or 2 resist dispenses and 1 solvent and 1  $N_2$  blow.

 3 gallon stainless steel tanks with metal sheathed teflon supply lines for solvents

P/N 0066 For HMDS, and Xylene with Viton seals P/N 0070 For N-Butyl Acetate, Acetone, EGMEA and Alcohols with EPR seals. See page 67 for chemical compatability table.

- Extra loading Paddle
- Spares Kit P/N 001525
- Pre-pump filter for positive or negative resist P/N 0255
- · Additional vacuum chucks see pages 64 and 65
- Small volume, disposable cartridge dispense system for multiple dispense applications